

## PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT6083656

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
ATSUSHI YUSA	01/28/2020
YUSUKE TAKAMURA	01/29/2020
KENICHI CHUJO	01/28/2020
HAJIME MIYAMOTO	01/28/2020
TOSHIO KAZAMI	03/25/2020
SATORU IRIYAMA	01/28/2020
MASAHIKO NAKAYAMA	01/30/2020
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	HONDA MOTOR CO., LTD.
<b>Street Address:</b>	1-1, MINAMI-AOYAMA 2-CHOME
<b>Internal Address:</b>	MINATO-KU
<b>City:</b>	TOKYO
<b>State/Country:</b>	JAPAN
<b>Postal Code:</b>	107-8556
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	16759929
<b>CORRESPONDENCE DATA</b>	
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<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	2165669700
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<b>Correspondent Name:</b>	RANKIN HILL AND CLARK LLP
<b>Address Line 1:</b>	38210 GLENN AVENUE
<b>Address Line 4:</b>	WILLOUGHBY, OHIO 44094
<b>ATTORNEY DOCKET NUMBER:</b>	SAT-47742
<b>NAME OF SUBMITTER:</b>	DAVID E. SPAW
<b>SIGNATURE:</b>	/David E. Spaw/

<b>DATE SIGNED:</b>	04/29/2020
<b>Total Attachments: 4</b> source=47742-Assignment#page1.tif source=47742-Assignment#page2.tif source=47742-Assignment#page3.tif source=47742-Assignment#page4.tif	

## ASSIGNMENT

WHEREAS, new and useful improvements have been made by the undersigned in

RESIN MOLDED ARTICLE UNIT AND METHOD FOR MOLDING RESIN MOLDED ARTICLE UNIT

that are the subject of an application for a U.S. Patent, (identified as Application No. 16/759929 filed on 04/28/2020), which application is still further identified as Rankin, Hill & Clark LLP Docket No. SAT-47742.

WHEREAS, HONDA MOTOR CO., LTD., a corporation of Japan, and having a place of business at 1-1, Minami-Aoyama 2-chome, Minato-ku, Tokyo 107-8556, Japan, hereinafter referred to as "assignee", is desirous of acquiring all right, title, and interest throughout the world in, to, and under said improvements and inventions and patent rights therefor.

NOW, THEREFORE, be it known that, for valuable consideration, the receipt and sufficiency of which are hereby acknowledged, all right, title, and interest, in the United States and throughout the world, in, to and under said improvements and inventions and all patents, patent applications, patent rights, and inventor's certificates thereof, therefor, and therein, including without limitation said application for patent in the United States, all divisions and continuations thereof, all patents which may be granted thereon, all reissues and extensions thereof, all right to sue for past infringement thereunder, all patents which may be granted for said improvements and inventions by states or nations other than the United States, or by other authority, entity, or organization, and all applications therefor, have been and are hereby sold, assigned, transferred, and delivered unto assignee, its successors and assigns; and it is covenanted and agreed by the undersigned, and for executors, administrators, and legal representatives of the undersigned, that at assignee's request any and all applications, affidavits, assignments, and other instruments will be made, executed, and delivered as may be necessary, or desirable to secure for or vest in assignee, its successors or assigns, any improvement, inventions, right, title, interest, application, patent, patent right or other right or property covered by this assignment, and the United States Commissioner of Patents and Trademarks is hereby requested and authorized to issue any and all United States patents granted on any of said applications to assignee as owner of the entire right, title, and interest in, to, and under the same, and appropriately empowered officials of foreign countries are hereby authorized to issue any letters patent granted on any of said applications to assignee as owner of the entire right, title and interest in, to, and under the same.

The undersigned hereby grants the firm of Rankin, Hill & Clark LLP the power to insert on this assignment any identification that may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

IN WITNESS WHEREOF, this assignment has been executed below by the undersigned:

(1) Inventor Name (sole or joint): Atsushi YUSA  
Signature: Atsushi Yusa  
Today's Date: January 28, 2020

Witness: [Signature]

Witness: [Signature]

(2) Inventor Name (joint): Yusuke TAKAMURA  
Signature: Yusuke Takamura  
Today's Date: January 29, 2020

Witness: [Signature]

Witness: [Signature]

(3) Inventor Name (joint): Kenichi CHUJO  
Signature: \_\_\_\_\_  
Today's Date: \_\_\_\_\_

Witness: \_\_\_\_\_

Witness: \_\_\_\_\_

(4) Inventor Name (joint): Hajime MIYAMOTO  
Signature: Hajime Miyamoto  
Today's Date: January 28, 2020

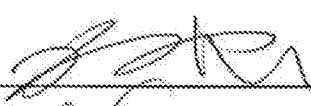
Witness: [Signature]

Witness: [Signature]

IN WITNESS WHEREOF, this assignment has been executed below by the undersigned:

(1) Inventor Name (sole or joint): Atsushi YUSA  
Signature: \_\_\_\_\_  
Today's Date: \_\_\_\_\_  
  
Witness: \_\_\_\_\_  
Witness: \_\_\_\_\_

(2) Inventor Name (joint): Yusuke TAKAMURA  
Signature: \_\_\_\_\_  
Today's Date: \_\_\_\_\_  
  
Witness: \_\_\_\_\_  
Witness: \_\_\_\_\_

(3) Inventor Name (joint): Kenichi CHUJO  
Signature: Kenichi Chujo  
Today's Date: January 28, 2020  
  
Witness:  \_\_\_\_\_  
Witness: Sp. G. Guro \_\_\_\_\_

(4) Inventor Name (joint): Hajime MIYAMOTO  
Signature: \_\_\_\_\_  
Today's Date: \_\_\_\_\_  
  
Witness: \_\_\_\_\_  
Witness: \_\_\_\_\_

(5) Inventor Name (joint): Toshio KAZAMI  
Signature: Toshio Kazami  
Today's Date: March 25, 2020

Witness: [Signature]  
Witness: [Signature]

(6) Inventor Name (joint): Satoru IRIYAMA  
Signature: Satoru Iriyama  
Today's Date: January 28, 2020

Witness: [Signature]  
Witness: [Signature]

(7) Inventor Name (joint): Masahiko NAKAYAMA  
Signature: Masahiko Nakayama  
Today's Date: January 30, 2020

Witness: [Signature]  
Witness: [Signature]